

### 概述 Description

- HL303X、HL304X、HL306X、HL308X 系列器件是由一个 GaAs 红外发光二极管和一个单晶硅芯片的过零相位光电双向晶闸管组成的光电耦合器。  
The HL303X, HL304X, HL306X and HL308X series devices are optical couplers composed of GaAs infrared light emitting diodes and zero-crossing phase photoelectric bidirectional thyristor of single crystal silicon chip.

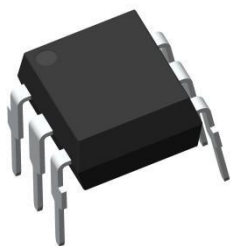
### 特性 Features

- 峰值击穿电压  
Peak breakdown voltage  
250V: HL303X;  
400V: HL304X;  
600V: HL306X;  
800V: HL308X;
- 输入-输出隔离电压 ( $V_{ISO}=5000$  Vrms )  
High isolation voltage between input and output( $V_{ISO}=5000$  Vrms )
- 工作温度:  $-55^{\circ}\text{C}\sim 110^{\circ}\text{C}$   
Operating Temperature:  $-55^{\circ}\text{C}\sim 110^{\circ}\text{C}$
- 符合加强绝缘标准  
Meet reinforced insulation standards
- 符合安规标准: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5) , CQC11-471543-2022  
Safety standards approval: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5) , CQC11-471543-2022

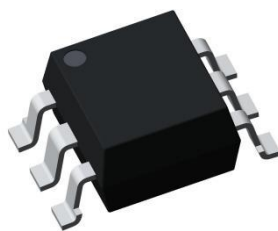
### 应用 Applications

- 开关电源, 智能电表  
Switching power supply, intelligent meter
- 工业控制, 测量仪器  
Industrial control, measuring instruments
- 办公设备, 比如复印机  
Office equipment such as copiers
- 家用电器, 比如空调、风扇、热水器等  
Household appliances: such as air conditioners, fans, water heaters, etc.

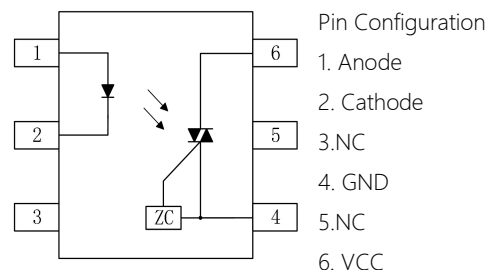
### 封装和原理图 Package and Schematic Diagram



DIP6



SMD6



### 产品型号命名规则 Order Code

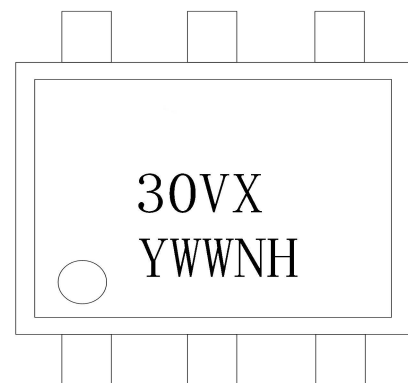
## HL 30VX - UN Y - W (V) (ZZ)

①            ②            ③    ④            ⑤            ⑥            ⑦

- ① 公司代码 Company Code (HL: 鸿利鲲鹏 Hongli Kunpeng)
- ② 产品系列 Product Series (30VX: 303X, 304X, 306X, 308X)
- ③ 框架类型 Lead Frame (Cu: 铜框架 Copper)
- ④ 树脂类型 Epoxy Type (H: 无卤 Halogen-free)
- ⑤ 封装形式 Package (D: DIP, S: SMD)
- ⑥ 器件工作温度范围 Device Operating Temperature Range (特殊范围需填或者空白 Special Range need to be filled in or left blank)
- ⑦ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or None)

### 印字信息 Marking Information

- 印字中的“V”代表 V<sub>DRM</sub> 分档: 3、4、6、8  
“V”denotes the V<sub>DRM</sub> digissr: 3、4、6、8
- 印字中的“X”代表 IFT 分档: 0、1、2、3  
“X”denotes the IFT digissr: 0、1、2、3
- 印字中“Y”代表年份; A(2018),B(2019),C(2020).....  
“Y”denotes YEAR: A(2018), B(2019), C(2020).....
- 印字中“WW”代表周号  
“WW”denotes Week's number
- 印字中“N”代表星期几  
“N”denotes the day of the week
- 印字中的“H”代表无卤  
“H”denotes Halogen-free



## 绝缘和安规信息 Insulation and Safety related specifications

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Remark
爬电距离 Creepage Distance	L	> 7.0	mm	从输入端到输出端, 沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body
电气间隙 Clearance Distance	L	> 7.0	mm	从输入端到输出端, 通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air
绝缘距离 Insulation Thickness	DTI	> 0.4	mm	发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector
峰值隔离电压 Peak Isolation Voltage	$V_{IORM}$	1500	$V_{peak}$	DIN/EN/IEC EN60747-5-5
瞬态隔离电压 Transient Isolation Voltage	$V_{IOTM}$	7000	$V_{peak}$	DIN/EN/IEC EN60747-5-5
隔离电压 Isolation Voltage	$V_{iso}$	> 5000	Vrms	For 1 min

极限参数 Absolute Maximum Ratings ( $T_a=25^{\circ}C$ )

参数 Parameter		符号 Symbol	额定值 Rating	单位 Unit	
发射端 Input	正向电流 Forward Current	$I_F$	60	mA	
	反向电压 Backward Voltage	$V_R$	6	V	
	功耗 Power Dissipation	$P_D$	100	mW	
	额定值降低因子(在 $T_a = 90^{\circ}C$ 以上) Power dissipation Derating factor (above $T_a = 90^{\circ}C$ )	$P_{DD}$	3.8	mW/ $^{\circ}C$	
接收端 output	断态输出端电压 Off-state output terminal voltage	$V_{DRM}$	HL303X	250	V
			HL304X	400	
			HL306X	600	
			HL308X	800	
	峰值重复浪涌电流( $p_w=100\mu s, 120pps$ ) Peak repetitive surge current ( $p_w=100\mu s, 120pps$ )	$I_{TSM}$	1	A	
开启态电流 (均方根值) On-state current (root mean square value)	$I_{T(RMS)}$	100	mA		
功耗 Power Dissipation	$P_C$	300	mW		
额定值降低因子(在 $T_a = 90^{\circ}C$ 以上) Power dissipation Derating factor (above $T_a = 90^{\circ}C$ )		7.6	mW/ $^{\circ}C$		
总功耗 Total Power Dissipation	$P_{tot}$	330	mW		
隔离电压 Isolation Voltage	$V_{iso}$	5000	V		

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参数 Parameter	符号 Symbol	额定值 Rating	单位 Unit
工作温度 Operating Temperature	$T_{opr}$	-55—110	°C
存储温度 Storage Temperature	$T_{stg}$	-55—125	°C
焊接温度 Soldering Temperature	$T_{sol}$	260	°C

\* 在相对湿度 40% ~ 60%下的进行交流电测试，此时 1、2 和 3 脚短接，4、。

\* Conduct AC test at 40%~60% relative humidity. At this time, pins 1, 2 and 3 are short-circuited, and pins 4, 5 and 6 are short-circuited.

### 产品特性参数 Electro-optical Characteristics (Ta=25°C)

参数 Parameter		符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit	
发射端 Input	正向电压 Forward Voltage	$V_F$	$I_F=20\text{mA}$	-	1.23	1.5	V	
	反向电流 Back current	$I_R$	$V_R=6\text{V}$	-	-	10	uA	
接收端 Output	断态峰值电流 Off-state peak current	QX303X	$V_{\text{DRM}} = \text{Rated } V_{\text{DRM}}$ $I_F = 0\text{mA}$	-	-	100	nA	
		QX304X		-	-	500		
		QX306X		-	-	500		
		QX308X		-	-	500		
	通态峰值电压 On-state peak voltage		$V_{\text{TM}}$	$I_{\text{TM}}=100\text{mA peak}$ $I_F = \text{Rated } I_{\text{FT}}$	-	-	3	V
	断态电压临界上升率 Critical rise rate of off-state voltage	QX303X	dv/dt	$V_{\text{PEAK}} = \text{Rated } V_{\text{DRM}}$ , $I_F=0$	1000	-	-	V/ $\mu\text{s}$
QX304X		600			-	-		
QX306X		600			-	-		
QX308X		600			-	-		
抑制电压 (MT1-MT2 高于多少电压不会触发) Suppression voltage (MT1-MT2 will not be triggered if it is higher than this voltage)		$V_{\text{inh}}$	$I_F = \text{Rated } I_{\text{FT}}$	-	-	20	V	
抑制状态的漏电流 Leakage current in suppression state		$I_{\text{DRM2}}$	$I_F = \text{Rated } I_{\text{FT}}$ , $V_{\text{DRM}} = \text{Rated } V_{\text{DRM}}$ , Off state	-	-	500	uA	
传输特性 Transfer Characteristics	LED 触发电流 LED trigger current	QX3031	$I_{\text{FT}}$	主端电压 Main terminal Voltage =3V	-	-	15	
		QX3041			-	-		
		QX3061			-	-		
		QX3081			-	-	10	
		QX3032			-	-		
		QX3042			-	-		
		QX3062			-	-		
		QX3082			-	-	5	
		QX3033			-	-		
		QX3043			-	-		
	QX3063	-	-					
QX3083	-	-						
维持电流 Maintain current		$I_H$	-	-	280	-	uA	

### 典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 LED forward current vs Forward voltage

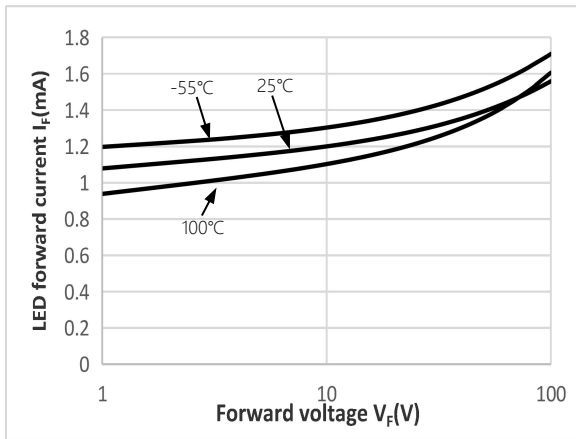


Fig.2 On-state characteristic diagram

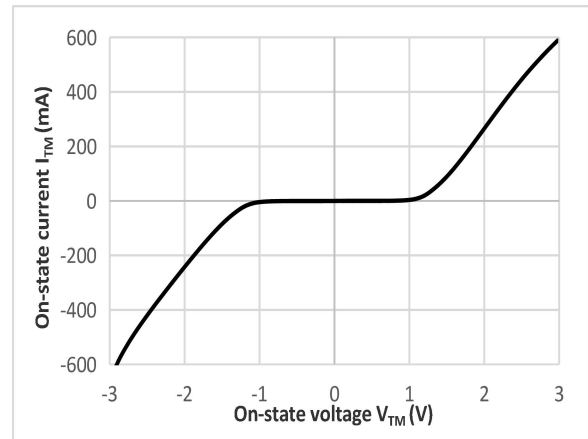


Fig.3 Trigger current vs Ambient temperature

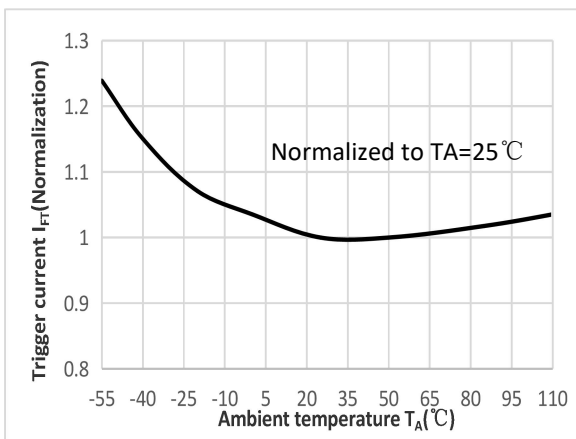


Fig.4 Trigger current vs LED pulse width

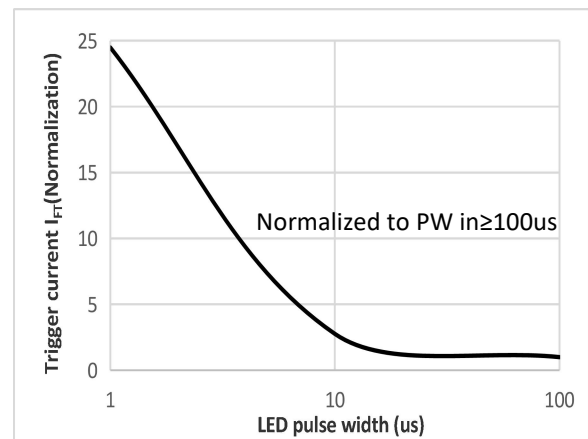


Fig.5 Maintenance current vs Ambient temperature

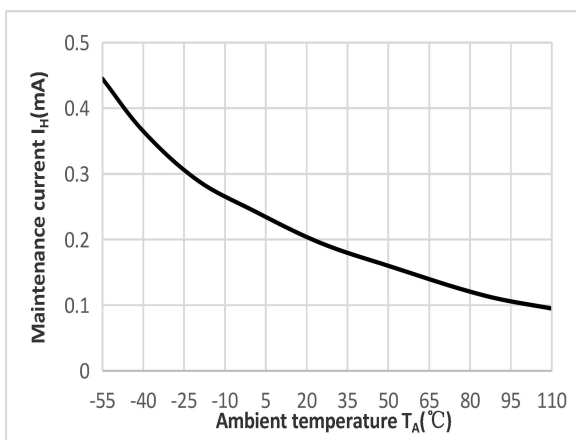


Fig.6 Leakage current vs Ambient temperature

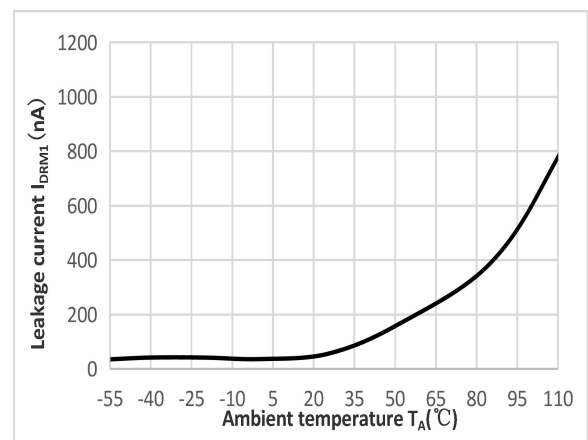


Fig.7 Suppressed state leakage current vs Ambient temperature

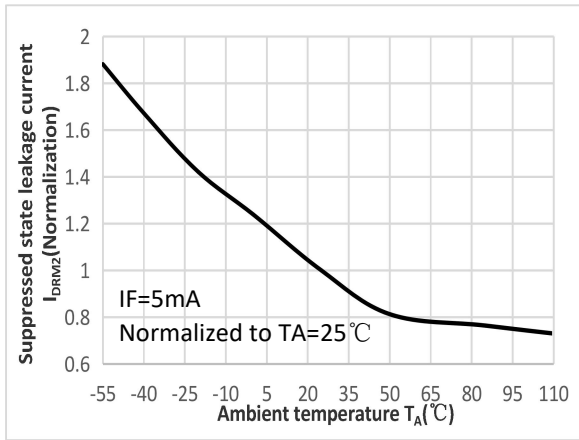


Fig.8 Suppression voltage vs Ambient temperature

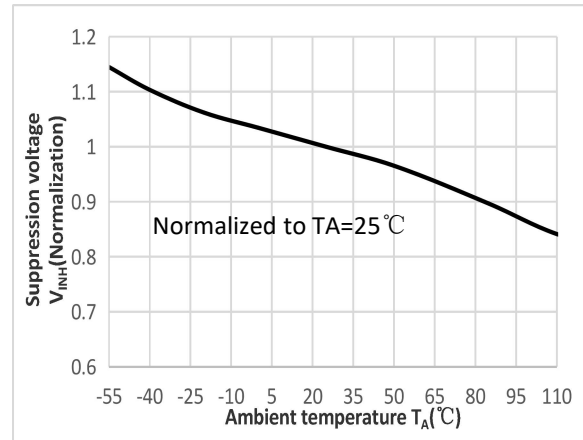
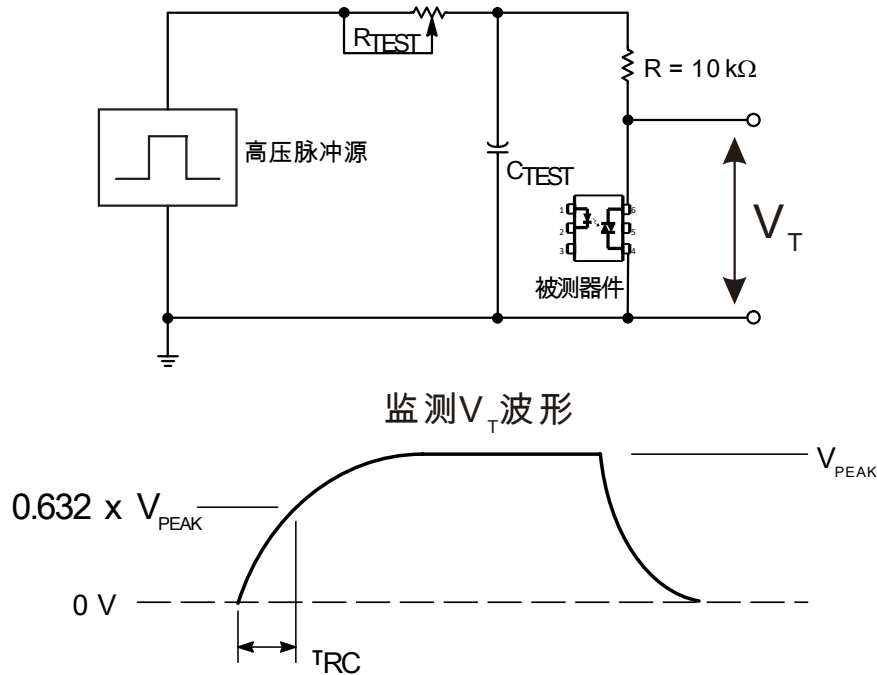


Fig.9 静态 dv/dt 测试电路和波形 Static dv/dt test circuit and waveform



通过 RC 电路施加于被测器件的输出端的高电压脉冲设置到所需的  $V_{PEAK}$  值上。LED 电流无需加上。波形  $V_T$  使用 X100 探头监测。通过调节  $R_{TEST}$  值， $dv/dt$  (斜度) 增加，直到被测器件观察到被触发 (波形崩溃)。  $dv/dt$  然后下降，直到被测器件停止被触发。此时，记录  $\tau_{RC}$  值并可计算  $dv/dt$  了。

The high voltage pulse applied to the output end of the device under test through the RC circuit is set to the desired  $V_{PEAK}$  value. LED current does not need to be added. Waveform  $V_T$  is monitored with X100 probe. By adjusting the  $R_{TEST}$  value,  $dv/dt$  (slope) increases until the device under test is observed to be triggered (waveform collapse).  $Dv/dt$  then drops until the device under test stops being triggered. At this time,  $dv/dt$  can be calculated by recording the value of  $\tau_{RC}$ .

$$dv/dt = \frac{0.632 \times 400}{\tau_{RC}} = \frac{252}{\tau_{RC}}$$

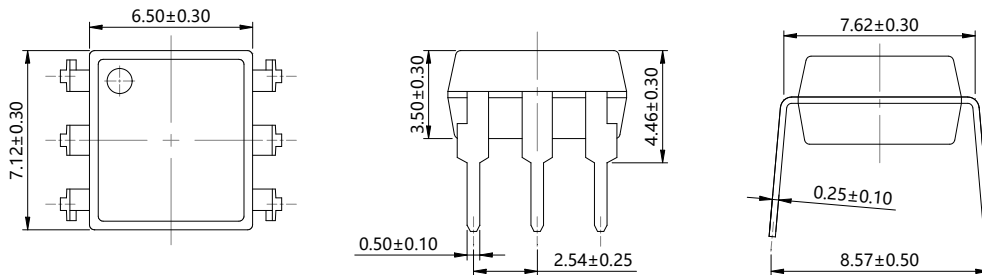
例如，QX304X 系列的电压峰值  $V_{PEAK} = 400V$ 。dv/dt 值的计算方式如下：

For example, the voltage peak of QX304X series  $V_{PEAK}=400V$ . Then the dv/dt value can be calculated as follows:

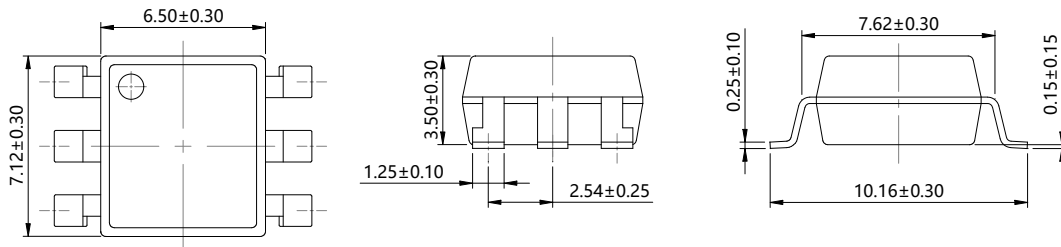
$$dv/dt = \frac{0.632 \times 400}{\tau_{RC}} = \frac{252}{\tau_{RC}}$$

### 外形尺寸 Outline Dimensions

DIP6

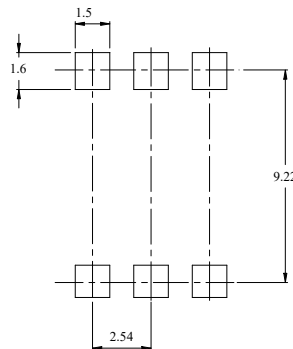


SMD6



单位 Unit: mm

### 建议焊盘布局 Recommended Pad Layout



注：上图为产品正视图。

Note: The picture above is the front view of the product.

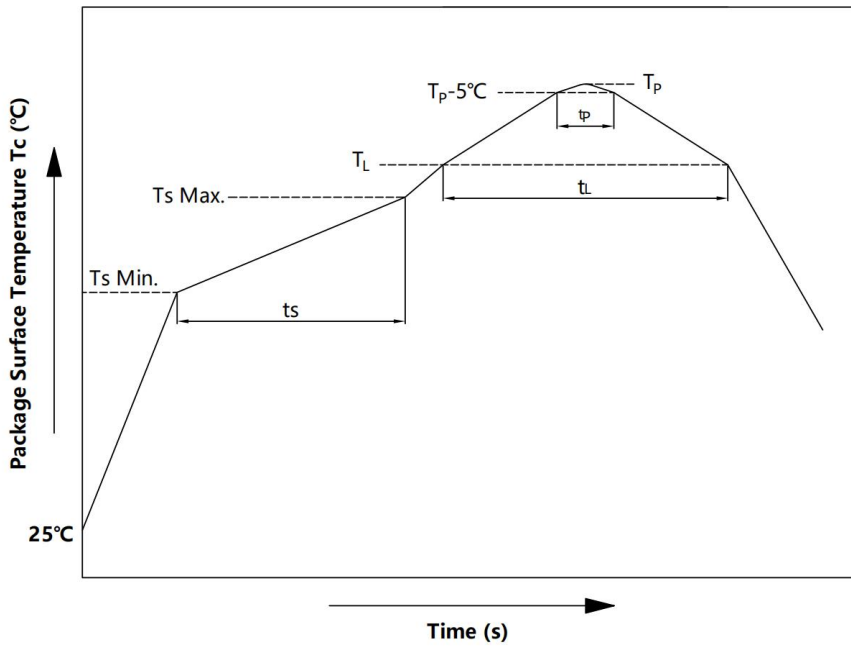
单位 Unit: mm

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### 回流焊温度曲线图 Solder Reflow Profile



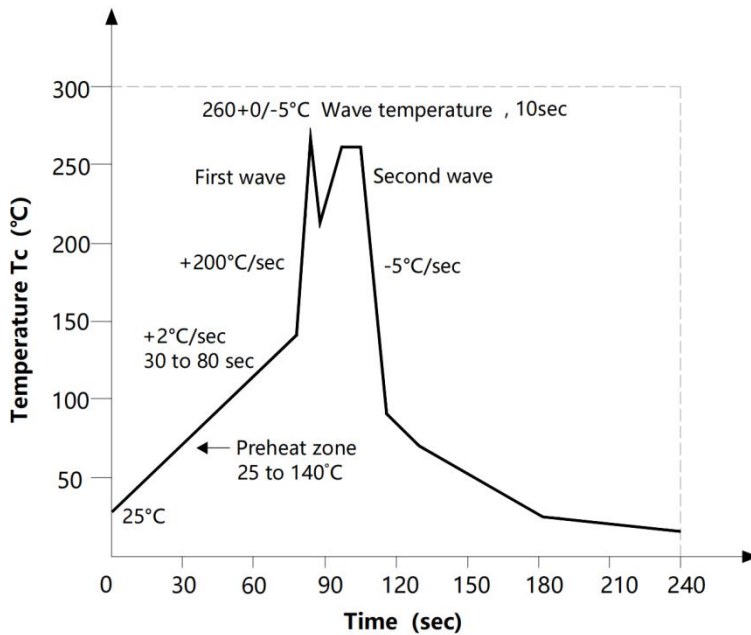
项目 Item	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
预热温度 Preheat Temperature	$T_s$	150	200	$^\circ\text{C}$
预热时间 Preheat Time	$t_s$	60	120	s
升温速率 Ramp-Up Rate ( $T_L$ to $T_P$ )	-	-	3	$^\circ\text{C}/\text{s}$
液相线温度 Liquidus Temperature	$T_L$	217		$^\circ\text{C}$
时间高于 $T_L$ Time Above $T_L$	$t_L$	60	150	s
峰值温度 Peak Temperature	$T_P$	-	260	$^\circ\text{C}$
$T_c$ 在 $(T_P - 5)$ 和 $T_P$ 之间的时间 Time During Which $T_c$ Is Between $(T_P - 5)$ and $T_P$	$t_p$	-	30	s
降温速率 Ramp-down Rate ( $T_P$ to $T_L$ )	-	-	6	$^\circ\text{C}/\text{s}$

注 Note:

建议在所示的温度和时间条件下进行回流焊，最多不能超过三次；

Reflow soldering is recommended at the temperatures and times shown, no more than three times;

### 波峰焊温度曲线图 Wave Soldering Profile



### 手工烙铁焊接 Soldering with hand soldering iron

- A. 手工烙铁焊仅用于产品返修或样品测试;  
Hand soldering iron is only used for product rework or sample testing;
- B. 手工烙铁焊要求: 温度  $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$ , 时间  $\leq 3\text{s}$ 。  
Hand soldering iron requirements: Temperature:  $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$ , within 3s

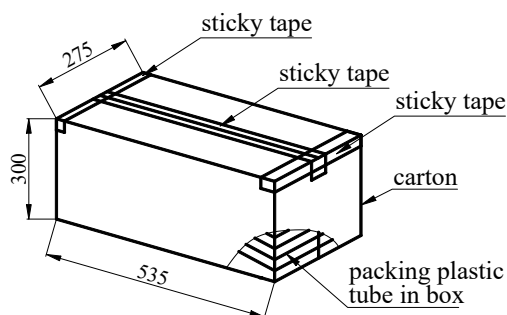
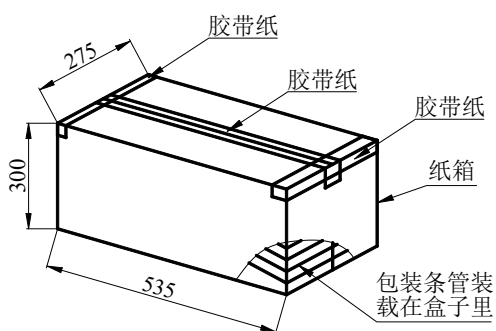
### 包装 Packing

#### ■ 汇总表 Summary table

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
DIP6	管装 (500*12*11mm)	65 只/管	50 管/盒	10 盒/箱	不适用	525*128*56mm	535*275*300mm	每管使用蓝白胶塞, 方向须一致
SMD6	卷盘 (φ330mm 蓝盘)	1000/盘	2 盘/盒	10 盒/箱	450*390*0.1mm	340*60*340mm	380*360*365mm	首尾端空至少 200mm
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
DIP6	Tube (500*12*11mm)	65 pcs /Tube	50 Tubes /box	10 boxes /ctn	Not applicable	525*128*56mm	535*275*300mm	Use blue and white rubber stoppers for each tube, with the same direction
SMD6	Reel (φ330mm Blue)	1k pcs/reel	2 reels /box	10 boxes /ctn	450*390*0.1mm	340*60*340mm	380*360*365mm	Leave at least 200mm of blank space at both ends

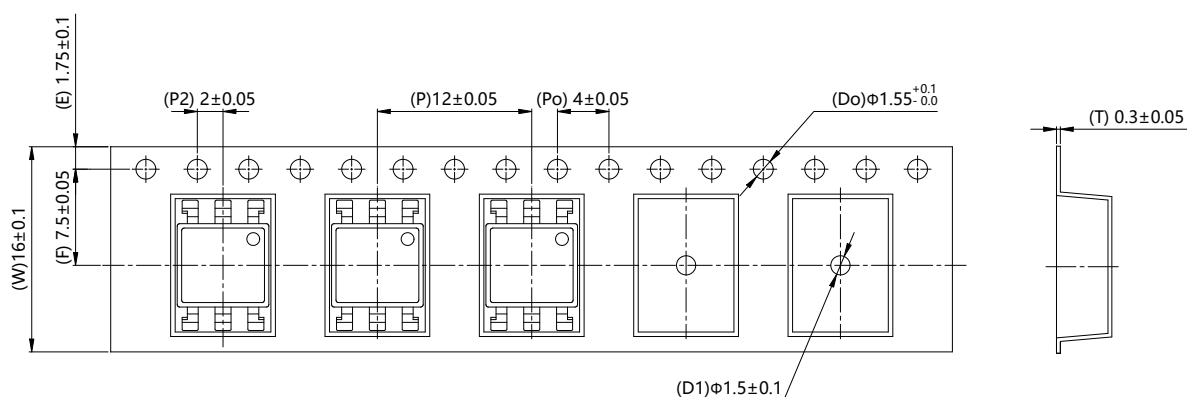
#### ■ 管条包装 Tape & Tube

- 1) 每管数量: 65 只。  
Qty/Tube: 65 pcs.
- 2) 每箱数量: 32500 只。  
Qty/ctn: 32500 pcs.
- 3) 内包装: 每盒 50 管。  
Inner packing: 50 Tube/box.
- 4) 示意图 Schematic:



### ■ 编带包装 Tape & Reel

- 1) 每卷数量: 1000 只。  
Qty/reel: 1000 pcs.
- 2) 每箱数量: 20000 只。  
Qty/ctn: 20000 pcs.
- 3) 内包装: 每盒 2 盘。  
Inner packing: 2 reels/box.
- 4) 示意图 Schematic:



单位 Unit: mm

### 注意 Attention

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